Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	"20040070020"	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/06 09:28
L2	0	("flipadjchipandgoldadjbump").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/06 09:29
L3	1192	flip adj chip and gold adj bump	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/02/06 12:45
L4	21490	high adj voltage and semiconductor and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR .	ON	2007/02/06 12:52
L5	1	"2003059947"	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/02/06 12:52
L7	3077	semiconductor and insulating adj substrate and field adj effect adj transistor and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/02/06 13:01
L8	82	thermally same conductive and mechanical adj joints	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/02/06 14:09
L9	129	gold adj bump and UBM	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/02/06 14:15
L10	. 629	USB AND FLASH ADJ DRIVE	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/02/06 14:34

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L11	1	"20030090884"	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/02/06 14:41
L12	1377	257/778 AND SILVER	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/02/06 14:41
S1	831	(257/680).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/04 23:13
S2	1	("6937479").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 10:20
S3	1655	(257/706).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 13:50
S5	0	"09420398680"	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 13:55
S7	0	TW09420398680	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 13:55
S8	0	TW09420398680A	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR ·	OFF	2007/02/05 13:55
S10	0	TW9420398680A	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 14:01
S11		("6528876").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 14:01

S12	6	("5482898"   "5598321"   "5977626"   "6008536"   "6208519"   "6246115").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/02/05 14:04
S13	10	(("5,216,278") or ("5,736,785") or ("5977,626") or ("6,522,428") or ("6,528,876") or ("6,462,405") or ("6,429,512") or ("6,433,420") or ("6,444,498") or ("6,458,626")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 14:04
S14	14	("5041902"   "5222014"   "5234867"   "5327104"   "5471366"   "5705851"   "5726079"   "6057381"   "6117797"   "6236568"   "6249434"   "6251707"   "6326678"   "6358776").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/02/05 14:18
S15	1	("5216278").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 14:43
S16	1	("6444498").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 15:13
S17	251	adhesive and perforation and chip and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF .	2007/02/05 15:13

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L1	1	"20040070020"	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/06 09:28
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L4	21490	high adj voltage and semiconductor and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/02/06 12:52
L5	1	"2003059947"	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/02/06 12:52
L7	3077	semiconductor and insulating adj substrate and field adj effect adj transistor and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/02/06 13:01
L8	82	thermally same conductive and mechanical adj joints	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/02/06 13:01
S1 .	831	(257/680).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/04 23:13
S2		("6937479").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 10:20

S3	1655	(257/706).CCLS.	US-PGPUB;	OR	OFF	2007/02/05 13:50
53	1000	(25///06).CCLS.	USPAT; USOCR; EPO; JPO; IBM_TDB	OK	OFF	2007/02/03 13:50
<b>S</b> 5	0	"09420398680"	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 13:55
S7	0	TW09420398680	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 13:55
S8	0	TW09420398680A	US-PGPUB; ·USPAT; ·USOCR; EPO; JPO; ·IBM_TDB	OR	OFF	2007/02/05 13:55
S10	0	TW9420398680A	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 14:01
S11	1	("6528876").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 14:01
S12	6	("5482898"   "5598321"   "5977626"   "6008536"   "6208519"   "6246115").PN.	US-PGPUB; USPAT; USOCR	OR .	OFF	2007/02/05 14:04
S13	10	(("5,216,278") or ("5,736,785") or ("5977,626") or ("6,522,428") or ("6,528,876") or ("6,462,405") or ("6,429,512") or ("6,433,420") or ("6,444,498") or ("6,458,626")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 14:04
S14	14	("5041902"   "5222014"   "5234867"   "5327104"   "5471366"   "5705851"   "5726079"   "6057381"   "6117797"   "6236568"   "6249434"   "6251707"   "6326678"   "6358776").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/02/05 14:18
S15	1	("5216278").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 14:43

S16	1	("6444498").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 15:13
S17	251	adhesive and perforation and chip and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/02/05 15:13

2/6/07 1:51:20 PM C:\Documents and Settings\nha1\My Documents\EAST\Workspaces\default.wsp Page 3